

STPSC1006

600 V power Schottky silicon carbide diode

Features

- No or negligible reverse recovery
- Switching behavior independent of temperature
- Particularly suitable in PFC boost diode function

Description

The SiC diode is an ultrahigh performance power Schottky diode. It is manufactured using a silicon carbide substrate. The wide band gap material allows the design of a Schottky diode structure with a 600 V rating. Due to the Schottky construction no recovery is shown at turn-off and ringing patterns are negligible. The minimal capacitive turn-off behavior is independent of temperature.

ST SiC diodes will boost the performance of PFC operations in hard switching conditions.

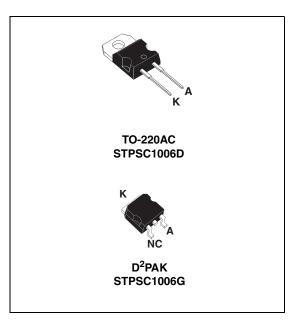


Table 1. Device summary

I _{F(AV)}	10 A
V _{RRM}	600 V
T _{j (max)}	175 °C
Q _{C (typ)}	12 nC

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1 Characteristics

Table 2. Absolute ratings (limiting values at 25 °C unless otherwise specified)

Symbol	Par	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		600	V
I _{F(RMS)}	Forward rms current		18	Α
I _{F(AV)}	Average forward current $T_c = 115$ °C, $\delta = 0.5$		10	Α
	Curren man remetitive formulard	$t_p = 10$ ms sinusoidal, $T_c = 25$ °C	40	
I _{FSM}	I _{FSM} Surge non repetitive forward current	t _p = 10 ms sinusoidal, T _c = 125 °C	32	Α
		$t_p = 10 \mu s \text{ square}, T_c = 25 ^{\circ}\text{C}$	160	
I _{FRM}	Repetitive peak forward current δ = 0.1, T_C = 110 °C, T_j = 150 °C		40	Α
T _{stg}	Storage temperature range		-55 to +175	°C
T _j	Operating junction temperature		-40 to +175	°C

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit	
R _{th(j-c)}	Junction to case	2	°C/W	

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage	T _j = 25 °C	V _R = V _{RRM}	-	30	150	μA
Current current	T _j = 150 °C	VR - VRRM	-	210	1500	μΑ	
V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	-	1.4	1.7	V	
V _F · / Folwa	T _j	T _j = 150 °C	IF - 10 A	-	1.6	2.1	V

^{1.} $t_p = 10 \text{ ms}, \ \delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 1.2 \text{ x } I_{F(AV)} + 0.09 \text{ x } I_{F^{2}(RMS)}$$

Table 5. Other parameters

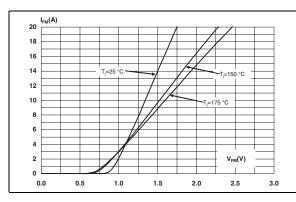
Symbol	Parameter	Test conditions	Тур.	Unit
Q _c	Total capacitive charge	$V_r = 400 \text{ V}, I_F = 10 \text{ A } dI_F/dt = -200 \text{ A/}\mu\text{s}$ $T_j = 150 ^{\circ}\text{C}$	12	nC
С	Total capacitance	$V_r = 0 \text{ V}, T_c = 25 \text{ °C}, F = 1 \text{ Mhz}$	650	рF
	Total Capacitatice	$V_r = 400 \text{ V}, T_c = 25 ^{\circ}\text{C}, F = 1 \text{ Mhz}$	50	ρι

^{2.} $t_p = 500 \ \mu s, \ \delta < 2\%$

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Figure 1. Forward voltage drop versus forward current (typical values)

Figure 2. Reverse leakage current versus reverse voltage applied (maximum values)



1.E+04

1.E+03

1.E+03

1.E+01

1.E+00

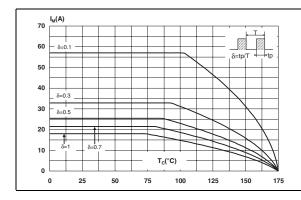
1.E+00

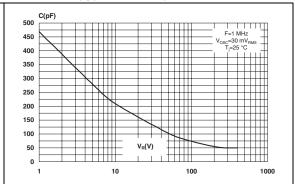
1.E+01

0 50 100 150 200 250 300 350 400 450 500 550 600

Figure 3. Peak forward current versus case temperature

Figure 4. Junction capacitance versus reverse voltage applied (typical values)

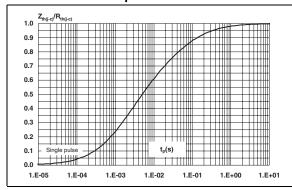




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Figure 5. Relative variation of thermal impedance junction to case versus pulse duration

Figure 6. Non-repetitive peak surge forward current versus pulse duration (sinusoidal waveform)



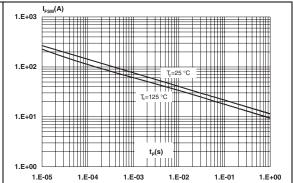
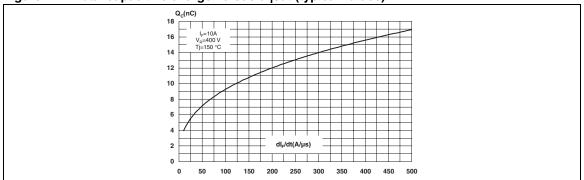


Figure 7. Total capacitive charge versus dl_F/dt (typical values)



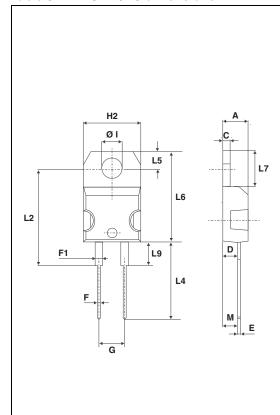
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2 Package information

- Epoxy meets UL94, V0
- Cooling method: convection (C)
- Recommended torque value: 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of $\mathsf{ECOPACK}^{\mathbb{B}}$ packages, depending on their level of environmental compliance. $\mathsf{ECOPACK}^{\mathbb{B}}$ specifications, grade definitions and product status are available at: $\mathit{www.st.com}$. $\mathsf{ECOPACK}^{\mathbb{B}}$ is an ST trademark.

Table 6. TO-220AC dimensions



	Dimensions				
Ref.	Millimeters		Inches		
	Min. Max.		Min.	Max.	
Α	4.40	4.60	0.173	0.181	
С	1.23	1.32	0.048	0.051	
D	2.40	2.72	0.094	0.107	
Е	0.49	0.70	0.019	0.027	
F	0.61	0.88	0.024	0.034	
F1	1.14	1.70	0.044 0.06		
G	4.95	5.15	0.194	0.202	
H2	10.00	10.40	0.393	0.409	
L2	16.40 typ.		0.645 typ.		
L4	13.00	14.00	0.511	0.551	
L5	2.65	2.95	0.104	0.116	
L6	15.25	15.75	0.600	0.620	
L7	6.20	6.60	0.244	0.259	
L9	3.50	3.93	0.137	0.154	
М	2.6 typ.		0.102	2 typ.	
Diam. I	3.75	3.85	0.147	0.151	

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Table 7. D²PAK dimensions

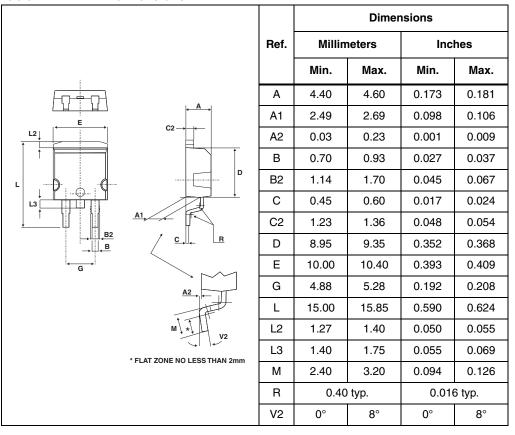
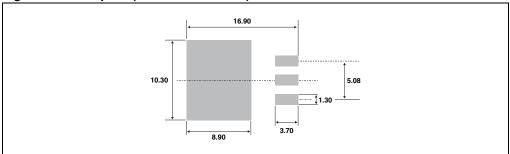


Figure 8. Footprint (dimensions in mm)



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3 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPSC1006D	STPSC1006D	TO-220AC	1.86 g	50	Tube
STPSC1006G-TR	STPSC1006G	D ² PAK	1.48 g	1000	Tape and reel

4 Revision history

Table 9. Document revision history

Date	Revision	Changes
24-Sep-2009	1	First issue.
16-Jun-2010	2	Added D ² PAK package.
3-Nov-2010	3	Updated Table 8.

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